

Title (en)
Multilayer ceramic substrate and its production method

Title (de)
Mehrschichtiges Keramiksubstrat und Verfahren zu dessen Herstellung

Title (fr)
Substrat céramique multicouche et son procédé de fabrication

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Application
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Abstract (en)
An object of the invention is to connect different dielectrics electrically to each other in the direction of main surface of a sheet in a multilayer ceramic substrate and to increase the degree of flexibility in design and make the multilayer ceramic substrate compact in size. A multilayer ceramic substrate in accordance with the invention is formed of a plurality of laminated ceramic substrates including such a composite ceramic substrate of different materials that is made by inserting the second ceramic substrate (6) in a pounched-out portion made in the first ceramic substrate (1) and by planarizing its top and bottom surfaces, wherein a conductive layer (11) is formed in a portion across a boundary between the first ceramic substrate and the second ceramic substrate of the interface of the composite ceramic substrate of different materials.

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Citation (examination)
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